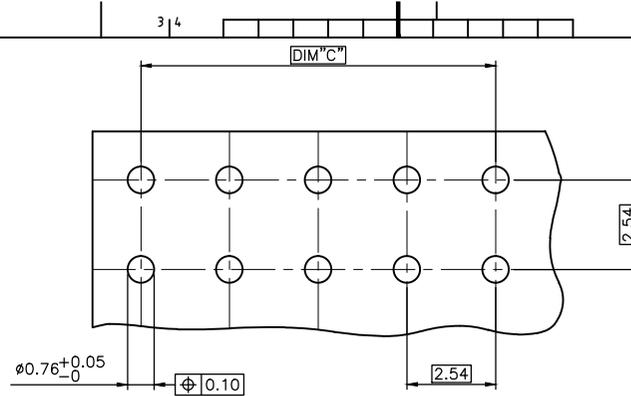
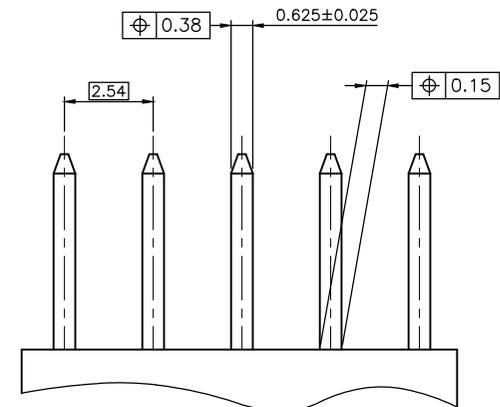


PRODUCT N°	DIM"C"	DIM"D"
91625-YXXLF	SEE TABLE SHEET 2/2	

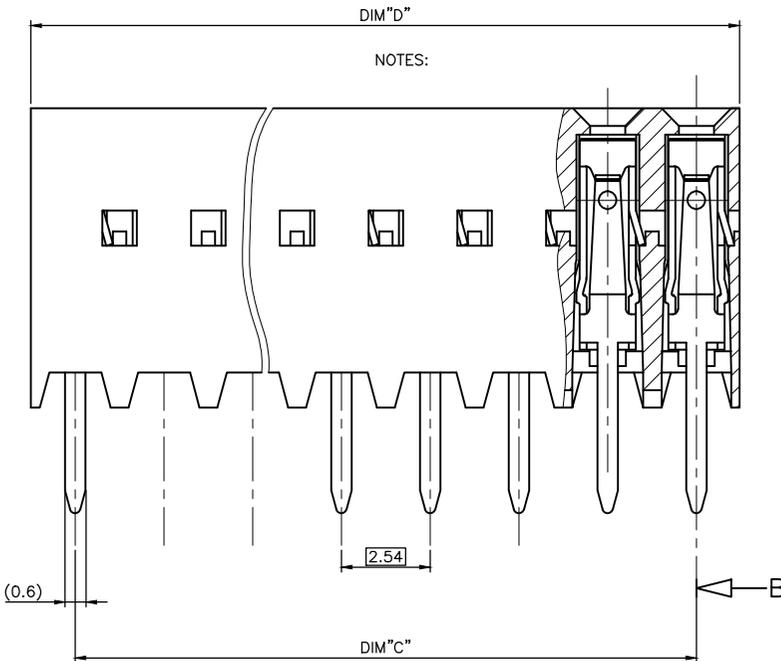
RoHS COMPATIBLE, SEE NOTE 4



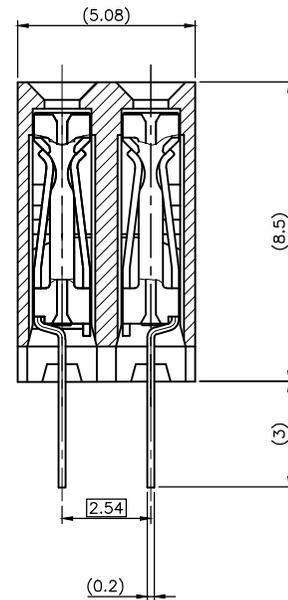
RECOMMENDED PC BOARD THICKNESS 1.6 mm MAX.



MINIMUM MATING PIN LENGTH: 5 mm.



NOTES:



SECTION B-B

NOTES:

- 1 - MATERIAL HOUSING: THERMOPLASTIC POLYESTER 30% GLASS FILLED, COLOUR BLUE. FLAME RETARDANT PER UL-94 CATEGORY V0.
- 2 - MATERIAL TERMINAL: PHOSPHOR BRONZE EXTRA HARD.
- 3 - CONNECTOR MEANT TO BE USED FOR PC BOARD WITH NONE PLATED THROUGH HOLES.
- 4 - RoHS COMPATIBLE PRODUCT SPECIFICATIONS
  - a - PLATING:
    - "LF" MEANS THE PRODUCT IS LEAD-FREE, 2µm MINIMUM MATTE TIN OVER 1.27µm MINIMUM NICKEL UNDERPLATE.
  - b - MANUFACTURING PROCESS COMPATIBILITY
    - THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.
  - c - LABELING:
    - MEETS PACKAGING SPECS AS PER GS-14-920
  - d - LEGAL STATEMENT: SEE GS-47-0004

91625-6XXLF	2 µm GOLD	Sn
91625-3XXLF	0.76 µm GOLD	Sn
PLATING CODE	CONTACT AREA	SOLDER TAIL
	PLATING THICKNESS OVER 1.27µm Ni	

mat'l. code	surface	tolerance	projection	product family
SEE NOTES	ISO 1302	ISO 406 ISO 1001		DX VCC DR
ltr ecn no dr date	tolerances unless otherwise specified	angles	linear	mm
K F07-0154 DLE 07.03.15				
L F07-0271 LMU 07.12.06				
M F11-0314 LMU 11.10.28				
N B-19124 LMU 14.10.21 dr	P.NIZZI	96.04.24	scale 10:1	dwg no
P B-21076 LMU 15.06.05 engr	JM.PHAMVAN	96.04.24		sheet 1 of 2 size
J F06-0204 DLE 06.06.23 appd	P.NIZZI	96.04.24		91625 A2
sheet revision P N	chr	JM.P		type CUSTOMER Drawing
index sheet 1 2				



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